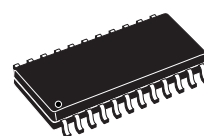




L5951

TRIPLE OUTPUT MULTIFUNCTION VOLTAGE REGULATOR FOR CAR RADIO WITH IDR/CLASS 2 INTERFACE

- 3 VOLTAGE REGULATORS:
3.3V (100mA) STANDBY REGULATOR
5V (100mA) STANDBY REGULATOR
7.8V (100mA)
- OUT OF REGULATION DETECTION FOR 5V-
STANDBY REGULATOR
- WIDE OPERATING SUPPLY VOLTAGE
RANGE FROM 4.5V UP TO 26.5V FOR
TRANSIENT 34V
- VERY LOW STANDBY QUIESCENT
CURRENT ($<150\mu\text{A}$)
- INPUT TO OUTPUT SIGNAL TRANSFER
FUNCTION PROGRAMMABLE
- LVS FUNCTION
- TTL AND CMOS COMPATIBLE INPUTS
- OUTPUT CURRENT LIMITATION
- CONTROLLED OUTPUT SLOPE FOR LOW
EMI
- OVERTEMPERATURE SHUT-DOWN
- ABLE TO SURVIVE UNDER LOSS OF



SO24

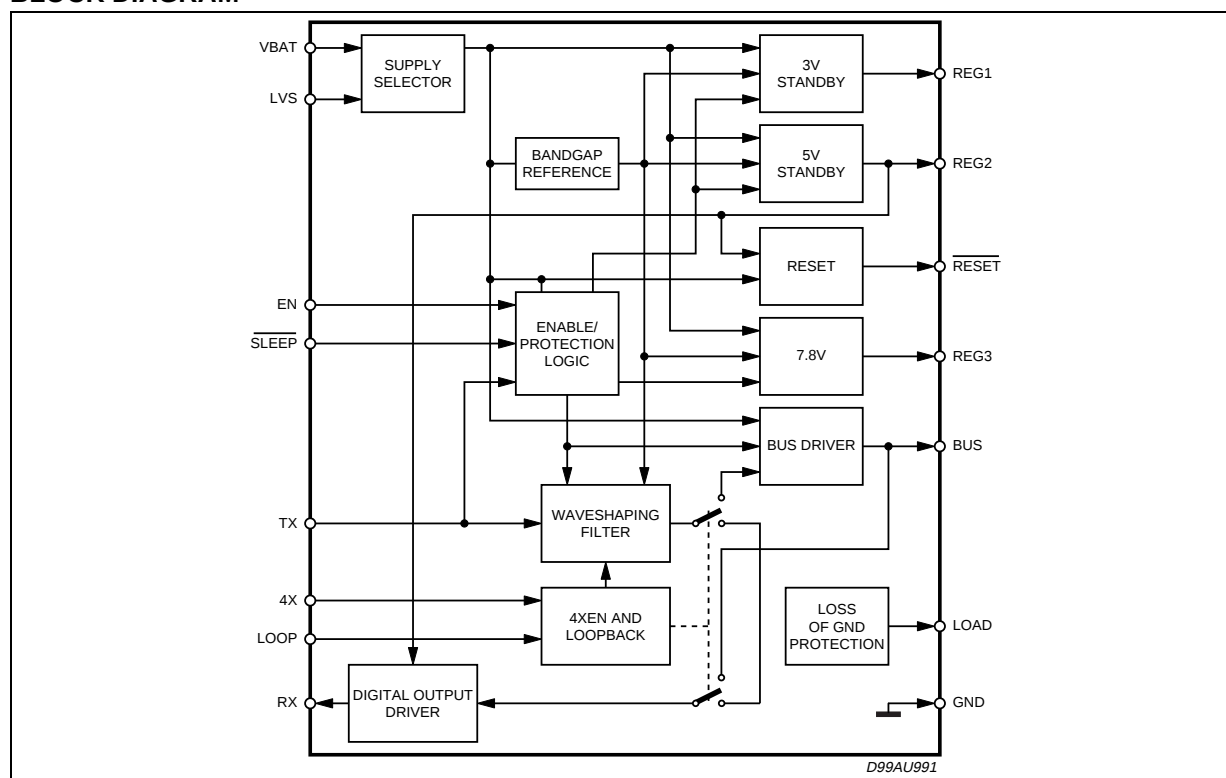
ORDERING NUMBER: L5951

- GROUND OR BATTERY
- ESD PROTECTED

DESCRIPTION

The L5951 is a monolithic triple regulator integrated with a SAE J1850 Integrated Driver / Receiver realized in advanced Multipower-BCD technology. It is intended to drive single wire J1850 communications, and offer microcontroller power and power management for automotive or industrial applications.

BLOCK DIAGRAM



1 FUNCTIONAL DESCRIPTION

1.1 General Features

The L5951 is an integrated circuit which provides a J1850 physical layer as well three voltage regulators. The L5951 was developed to provide the power and Class 2/IDR interface for a microcontroller.

1.2 REG1 Output Voltage

The REG1 regulator output is equal to 3.3V. The 3.3V regulator is non low drop out and can handle currents up to 100mA with short circuit limit of 280mA.

1.3 REG2 Output Voltage

The REG2 regulator output is equal to 5V and can handle currents up to 100mA with short circuit limit of 280mA. The output stage of the 5V regulator is low dropout.

1.4 REG3 Output Voltage

The REG3 regulator output is equal to 7.8V and can handle currents up to 100mA with short circuit limit of 280mA. The output stage of the 7.8V regulator is low dropout. REG3 regulator is controlled by the EN (enable) pin of the IC. REG3 can be turned on and off by toggling the EN pin. A logic "1" on the EN pin enables REG3, while a logic "0" on the EN pin disables REG3. The maximum voltage when REG3 is off must be less than 0.2V.

Sleep* Input - The Class 2 transmitter can be turned on and turned off by the Sleep* pin. Once the voltage level is above 2VDC, the transmitter is enabled. If the Sleep* pin drops below 0.8VDC, and EN is "0" the transceiver goes into a low power mode. In low power mode, REG3 and the transceiver are disabled. The L5951 will still receive messages and send them to the microcontroller out of the RX pin.

* denotes active low

LVS input - Reg1 and Reg2 are supplied by Vbat pin. The device could then dissipate a lot of power, causing thermal shutdown at high voltage. For this reason a secondary low voltage supply (LVS) can be used to reduce power dissipation.

Reset* Output - The L5951 has low voltage or no voltage circuitry that is a warning to the microcontroller. If REG2 drops 0.3VDC below its normal operating voltage, the Reset* pin will go to a logic "0". Between the voltage levels of 4.65VDC (min) and 5.10VDC (max) on REG2, a reset will occur. There is a hysteresis of 50mV on the Reset* pin.

* denotes active low

Low Input Voltage Operation - If battery voltage level drops below 7.0V, the outputs are to remain alive and ready for the return of normal voltage battery levels. The L5951 will be able to retrieve data off the BUS and send it to the microprocessor when the supply voltage is as low as 4.9V. The regulators should stay the same voltage as the battery voltage down to 7.0V minus operating headroom for the 7.8V regulator. BUS $V_{OH,min}$ are not guaranteed over all conditions below $V_{BAT} = 9.0V$.

Waveshaping - Messages sent by the microcontroller to the transceiver are routed to a waveshaping circuit. The digital signal is rounded at the switching points in order to reduce EMI emissions. A second order function, $I = C \cdot dV/dt$, is used to control the rise and fall times of the transmission. The rise and fall times are controlled by an external resistor R_{ext} . The waveshaping circuit can be enabled and disabled by the 4X pin. A logic "1" will disable the waveshape circuit and a logic "0" will enable the waveshape circuit. In 4X mode, the speed of the BUS is increased by a factor of four. Any signal coming from the microcontroller and going to the BUS must be waveshaped. If loopback(LOOP) is enabled, the signal coming from the micro through the TX pin is routed to the RX pin back to the micro with or without it being waveshaped. A logic "1" enables loopback and a logic "0" disables loopback.

Nodes - The transmitter provides a wave-shaped 0 to 7.7 VDC waveform on the BUS output. It also receives waveforms and transmits a digital level signal back to a logic IC. The transmitter can drive up to 32 remote transceivers. These remote nodes may be at ground potentials that are ± 2 VDC, with respect to the assembly. Under this condition, waveshaping will only be maintained during 3 of the 4 corners. The L5951 is a remote node on the Class 2/IDR Bus. Each remote transceiver has a $470 \pm 10\%$ pF capacitor on its output for EMI suppression,

as well as a 10.6 k Ω + 5% pull down resistor to ground. The main node has a 3,300 + 10% pF capacitor on its output for EMI suppression, as well as a 1.5 k Ω + 5% pull down resistor to ground. With more than 26 nodes there is no primary node, all nodes will have the 470 $\pm$ 10% pF capacitor and the 10.6k Ω $\pm$ 5% pull down resistor. No matter how many remote nodes are on the Class 2/IDR Bus, the RC of the Class 2/IDR Bus is maintained at approximately 5ms. The minimum and maximum load on the Class 2/IDR Bus is given below:

	Capacitance	Resistance to Ground
Minimum Nodes	$(3.33 \cdot .9) + (.47 \cdot .9) = 3.39 \text{ nF}$	$(1.5 \cdot 1.05) \parallel (10.6 \cdot 1.05) = 1.38 \text{ k}\Omega$
Maximum Nodes	$(3.3 \cdot 1.1) + 25 \cdot (0.47 \cdot 1.1) = 16.55 \text{ nF}$	$(1.5 \cdot 0.95) \parallel (10.6 \cdot 0.95) / 25 = 314\Omega$

1.5 Protection

The L5951 can survive under the following conditions: shorting the outputs to BAT and GND, loss of BAT, loss of IC GND, double battery(+26.5V), 4000V ESD, 34V load dump. L5951 will not handle a reverse battery condition. External components must be implemented for reverse battery protection.

Thermal Shutdown: thermal shutdown is broken down into two areas; V1 and V2 outputs, and the other is V3 output and the Class 2 Bus Driver. V1 and V2 outputs shutdown at 160°C and returns to normal operation at 130°C. The V3 output and Class 2 Bus Driver shutdown at 150°C and return to normal operation at 120°C.

Current Limiting: each voltage regulator will contain its own current protection, and the maximum allowable current for all three regulators is 280mA.

Short Circuit: If the outputs are short circuited, the IC will begin current limiting and eventually the thermal shutdown will kick in. Current limiting will not disable the outputs.

Overvoltage: The IC will not operate if the BAT voltage reaches 30V or above. V1 and V2 will not be shutdown, but all other outputs will not operate.

Loss of Ground & Loss of Battery Connection: in this conditions a very small leakage on BUS is generated.

1.6 Protocol Description

The L5951 uses a Variable Pulse Width (VPW) modulated protocol. One frame consists of an entire message not containing more than 12 bytes. The first bit of each byte will be the most significant bit (MSB). A transmitted message begins with a SOF signal and ends with the EOF signal.

The data to be transmitted has to be in a specific format as follows:

idle, SOF, DATA, CRC, EOD, NB, IFR, EOF, IFS, idle

Definitions below:

idle: Logic level low on communication bus
 SOF: Start of Frame
 DATA: Data Bytes
 CRC: Cyclic Redundancy Check Error Detection Byte
 EOD: End of DATA(only when IFR is used)
 NB: Normalization Bit
 IFR: In-Frame Response Byte(s)
 EOF: End of Frame
 IFS: Inter-Frame Separation
 BRK: Break(can occur on network at any time)

Idle - Logic level low on bus any time after IFS.

Start of Frame (SOF) - The SOF signals the receiver that a new frame is beginning. SOF signal is a logic level

high pulse identified by a pulse width of about $t = 200\mu\text{s}$.

DATA - Total number of bytes that can be transmitted (from SOF to EOF) is 12 bytes.

Cyclic Redundancy Check (CRC) - A method for determining if the message received is the same as the message transmitted. If an invalid CRC number is detected, then an error will be detected. The SOF signal is not used to determine the CRC. All bits in the CRC are initially "ones" to avoid confusion with a data stream that are all "zeros".

End of Data (EOD) - Used to signal the receiver about the end of data transmission. If there is a IFR signal, the sender of the frame will expect one or more bytes in the IFR following the EOD. If there is no IFR used, then the bus would stay in a logic level low state resulting in a EOF. EOD signal is recognized by a logic level low pulse for a duration of about $200\mu\text{s}$.

Normalization Bit (NB) - The sole reason for the NB is to define the start of the in-frame response. The first bit the the IFR is passive, therefore it is necessary to have a signal that follows EOD. There are two forms to the NB. First of all, the NB is a logic level high pulse. The two forms are distinguished by thier pulse widths. The first form has a pulse width of about $64\mu\text{s}$ and indicates if the IFR contains a CRC or not. The second form has a longer pulse width of about $128\mu\text{s}$ and also indicates if there is a CRC in the IFR or not. The manufacturer can manipulate the NB to any of the two methods.

In-Frame Response (IFR) - Response bytes are sent by the receiver of the transmission and start after the EOD. If the IFR stays at a logic level low for a period of time then the frame must be considered to be complete. IFR bytes can be used to send a signal back to the originator indicating the correct CRC number to confirm the correct message was sent.

End of Frame (EOF) - Indicates the end of a frame. Once the last byte is transmitted, the bus will be in a logic level low state for a period of time indicating the end of the frame. EOF signal is recognized by a low pulse for a width of about $280\mu\text{s}$.

Inter-Frame Separation (IFS) - IFS is used to synchronize the receivers at various nodes.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_S	DC Operating Supply Voltage	-0.6 to 26.5	V
V_{DIAG}	Diagnostic output voltage	-0.6 to 5.5	V
V_{IN}	Input Control Voltage (EN, $\overline{\text{Sleep}}$, 4X, Loop, TX)	-0.6 to 5.5	V
V_{OUT}	Output Control Voltage (Reset *)	-0.3 to 5.5	V
V_S	Peak Supply Voltage $t = 50\text{ms}$	34	V
T_{op}	Operating Temperature Range	-40 to 85	°C
T_{stg}	Storage Temperature Range	-40 to 150	°C

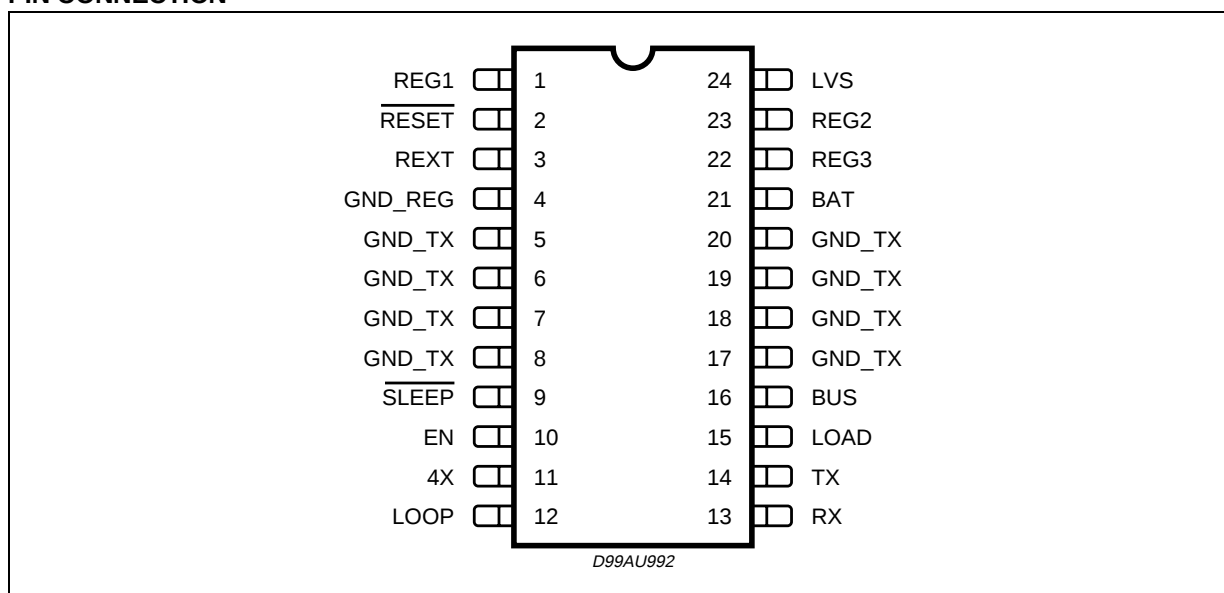
* denotes active low

THERMAL DATA

Symbol	Parameter	Value	Unit
$R_{\text{th j-amb}}$	Thermal resistance junction to ambient (*)	50	°C/W

(*) With 6cm^2 on board heat sink area.

PIN CONNECTION



PIN FUNCTIONS

N.	Name	Function
1	REG1	Regulator #1
2	Reset *	Reset Output to μ C
3	Rext	Waveshaping Resistor
4	GND_REG	Regulator Ground
6,7,8,17, 18,19,20	GND_TX	Transceiver Ground
9	Sleep *	Transceiver Enable Input
10	EN	Enable for Regulator #3
11	4X	4XBus mode (41.6K Baud)
12	LOOP	Loopback Enable
13	RX	Serial Data Output to mC
14	TX	Serial Data Input from mC
15	Load	External Pull Down to Gnd
16	Bus	Bus Output to Vehicle
21	Bat	Battery Supply
22	REG3	Regulator #3
23	REG2	Regulator #2
24	LVS	Low Voltage Supply

*denotes active low for Sleep and Reset.

ELECTRICAL CHARACTERISTICS

($T_{amb} = 25^{\circ}\text{C}$, $V_{BAT} = 14.4\text{V}$ unless otherwise specified. Standard Loads: $I_{REG1} = 0.5\text{mA}$, $I_{REG2} = 0.5\text{mA}$, $I_{REG3} = 5\text{mA}$)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$I_{q,ST-BY}$	Standby Quiescent Current	EN, Sleep* = 0V, $V_{BAT} = 14\text{V}$, $I_{REG2} = 50\text{mA}$, $I_{REG1} = 50\text{mA}$ EN, Sleep* = 0V, $V_{BAT} = 14\text{V}$, $I_{REG2} = 500\mu\text{A}$, $I_{REG1} = 250\text{mA}$		350 110		μA μA
	Maximum Quiescent Current - V_{BAT}	$V_{BAT} = 14\text{V}$, $I_{REG1} = 100\text{mA}$, $I_{REG2} = 100\text{mA}$, $I_{REG3} = 100\text{mA}$, $I_{BUS} = 30\text{mA}$ LVS = 0V LVS = 10V		10 10.5		mA mA
	Maximum Quiescent Current - LVS	$V_{BAT} = 14\text{V}$, $I_{REG1} = 100\text{mA}$, $I_{REG2} = 100\text{mA}$, $I_{REG3} = 100\text{mA}$, $I_{BUS} = 30\text{mA}$ LVS = 10V		750		μA
	EN Switch Input Current	$V_{BAT} = 14\text{V}$, EN $\geq 2\text{V}$ $V_{BAT} = 14\text{V}$, EN $\geq 0.8\text{V}$		0 0		μA μA
$V_{ENL, ENH}$	EN Input Threshold Voltage	$V_{BAT} = 14\text{V}$, VIL $V_{BAT} = 14\text{V}$, VIH	2		0.8	V
$V_{RES, L}$	Reset* Output Low Voltage	Set V_{BAT} so V_{REG2} drops 0.30V	0	0.02	0.4	V
V_{RES}	Reset* Output Voltage Threshold	Decrease V_{BAT} so V_{REG2} drops until Reset* drops		V_{REG2} - 0.20		V
$V_{RES, HYS}$	Reset Threshold Hysteresis			50		mV

(*) Denotes active low.

3.3V/100mA DC Characteristics for Regulator Output 1

V_{REG1}	Output Voltage	$I_{REG1} = 100\text{mA}$	3.14	3.3	3.46	V
ΔV_{line}	Line Regulation	$7\text{V} \leq V_{BAT} \leq 26\text{V}$ (Measure ΔV_{REG1} Across V_{BAT} Range)		7	15	mV
ΔV_{load}	Load Regulation	$0.5\text{mA} \leq I_{REG1} \leq 100\text{mA}$ (Measure ΔV_{REG1} Across V_{LOAD} Range)		8	50	mV
$V_{DROPOUT}$	Dropout Voltage (Measure $V_{BAT} - V_{REG1}$ when V_{REG1} drops 0.1V)	$I_{REG1} = 100\text{mA}$ $I_{REG1} = 5\text{mA}$		1 0.12	2.2 1.5	V V
I_{lim1}	Current Limit			200		mA
SVR1	Reg1 Supply Voltage Rejection	$I_{REG1} = I_{REG2} = I_{REG3} = 50\text{mA}$ $f = 20$ to 20kHz $V_{BAT} = 14\text{Vdc}$, 1Vac,pp		45		dB

5V/100mA Regulator Output 2

V_{REG2}	Output Voltage	$I_{REG2} = 100\text{mA}$	4.75	5	5.25	V
ΔV_{line}	Line Regulation	$7\text{V} \leq V_{BAT} \leq 26\text{V}$ (Measure ΔV_{REG2} Across V_{BAT} Range)		6	40	mV

ELECTRICAL CHARACTERISTICS (continued)(T_{amb} = 25°C, V_{BAT} = 14.4V unless otherwise specified. Standard Loads: I_{REG1} = 0.5mA, I_{REG2} = 0.5mA, I_{REG3} = 5mA)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
ΔV_{load}	Load Regulation	$0.5mA \leq I_{REG2} \leq 100mA$ (Measure ΔV_{REG2} Across V_{LOAD} Range)		14	100	mV
V _{DROPOUT}	Dropout Voltage (Measure V _{BAT} - V _{REG2} when V _{REG2} drops 0.1V)	I _{REG2} = 100mA I _{REG2} = 5mA		450 22		mV mV
I _{lim2}	Current Limit			200		mA
SVR2	Reg2 Supply Voltage Rejection	I _{REG1} = I _{REG2} = I _{REG3} = 50mA f = 20 to 20kHz V _{BAT} = 14Vdc, 1Vac,pp		45		dB
7.8V/100mA Regulator Output 3						
V _{REG3}	Output Voltage	I _{REG3} = 100mA - $8.8V \leq V_{BAT} \leq$ Range	7.60	7.8	8	V
DV _{line}	Line Regulation	$8.8V \leq V_{BAT} \leq 26V$ (Measure ΔV_{REG3} Across V _{BAT} Range)			50	mV
DV _{load}	Load Regulation	$5mA \leq I_{REG3} \leq 100mA$ (Measure ΔV_{REG3} Across V_{LOAD} Range)			50	mV
V _{DROPOUT}	Dropout Voltage (Measure V _{BAT} - V _{REG3} when V _{REG3} drops 0.1V)	I _{REG3} = 100mA I _{REG3} = 5mA		0.5 0.04		V V
I _{lim3}	Current Limit			200		mA
SVR3	Reg3 Supply Voltage Rejection	I _{REG1} = I _{REG2} = I _{REG3} = 50mA f = 20 to 20kHz V _{BAT} = 14Vdc, 1Vac,pp		45		dB

DC Characteristics for Class 2 TransceiverStandard Loads: I_{REG1} = 0.5mA, I_{REG2} = 0.5mA, I_{REG3} = 5mA

BUS _{ih} BUS _{il}	BUS Guaranteed Input Voltages	Verify RX > 3 VDC Verify RX < 3 VDC	4.25	3.7	3.50	V V
BUS _{Hyst}	BUS Hysteresis	BUS _{ltoh} - BUS _{hhtol}		0.15		V
BUS _{ov}	BUS Output Voltage	TX = 5 VDC, BUS = 257 to 1380Ω to gnd V _{BAT} - 8.2 to 16 VDC V _{BAT} - 6.0 to 8.2 VDC TX = 0V		7.2 5		V V
I _{BUSshort}	BUS Short Circuit Current	TX = 5VDC BUS = -2 to 4.8VDC		170		mA
I _{BUSleak}	BUS Leakage Current	BUS = -2 to 0 VDC BUS = 0 to V _{BAT}		0 0		mA mA
LOAD _{ON}	Load Output	I _{LOAD} = 6mA		0.045		V

ELECTRICAL CHARACTERISTICS (continued)(T_{amb} = 25°C, V_{BAT} = 14.4V unless otherwise specified. Standard Loads: I_{REG1} = 0.5mA, I_{REG2} = 0.5mA, I_{REG3} = 5mA)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
LOAD _{Dio}	Load Output (Unpowered)	V _{BAT} = 0V, I _{LOAD} = 6mA		0.7		V
I _{BUSloss} I _{LOADloss}	BUS & LOAD Current during loss of assembly V _{BAT} or GND	I _{VBAT} = 0mA, BUS = -18 to 9VDC LOAD = -18 to 0 VDC		11 39		μA μA
TX _{VIL} TX _{VIH}	TX Input Voltage	Verify BUS < 3.875VDC Verify BUS > 3.875VDC	2		0.8	V V
I _{TXVIL} I _{TXVIH}	TX Input Current	TX = 5VDC TX = 0VDC		110 0		μA μA
4 _{Trip1} 4 _{Trip2}	4X Input Trip Point Voltages	Normal Mode 4X Mode		1.4		V
I _{4Xvih} I _{4Xvil}	4X Input Current	4X = 5 VDC 4X = 0 VDC		0 0		μA μA
L _{Trip1} L _{Trip2}	LOOP Input Trip Point Voltages	Normal Mode Loopback Mode	2		0.8	V V
I _{Lvih} I _{Lvil}	LOOP Input Current	LOOP = 5VDC LOOP = 0VDC		0		μA
V _{RXhigh}	RX Output Voltage, High	BUS = 7V, I _{RX} = -200μA		4.85		V
V _{RXlow}	RX Output Voltage, Low	BUS = 0V, I _{RX} = 1.6mA		0.2		V
I _{RX}	RX Output Current	RX = high (Short circuit protection limits)		5		mA
Sleep* V _{IH} Sleep* V _{IL}	Sleep* Input Voltage	TX = 5VDC Verify BUS > 3.725 Verify BUS < 4.025	2		0.8	V V
I _{Sleepvih} I _{Sleepvil}	Sleep* Input Current	Sleep* = 5VDC Sleep* = 0VDC		0.2 0		μA μA

* Denotes active low for Sleep and Reset.

AC Characteristics for Class 2 TransceiverStandard Loads: I_{REG1} = 0.5mA, I_{REG2} = 0.5mA, I_{REG3} = 5mA

BUS _{LOH}	BUS Voltage Rise Times	TX = 7.812Hz square wave See Figure 1 Min and Max Loaded BUS		15		μs
BUS _{HTOL}	BUS Voltage Fall Times	TX = 7.812Hz square wave See Figure 1 Min and Max Loaded BUS		14		μs
t _{Wbus}	BUS Pulse Width Distortion	TX = 7.812Hz square wave See Figure 2 Load BUS with 3.300pF and 1.38kΩ Meas. @ 1.5V levels Meas. @ 6.25V levels		77 48		μs μs

ELECTRICAL CHARACTERISTICS (continued)

($T_{amb} = 25^{\circ}\text{C}$, $V_{BAT} = 14.4\text{V}$ unless otherwise specified. Standard Loads: $I_{REG1} = 0.5\text{mA}$, $I_{REG2} = 0.5\text{mA}$, $I_{REG3} = 5\text{mA}$)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V1	Spectral Content Limit (Measure spectral peak from 0.53MHz to 1.6MHz)	$V_{BAT} = 9\text{V to } 16\text{V}$, no ground offset, $0.53 \leq f \leq 1\text{MHz}$. $V_{BAT} = 9\text{V to } 16\text{V}$, no ground offset, $1 \leq f \leq 1.67\text{MHz}$.		100		μV
V2				80		μV
BUS _{DLY}	Propagation Delay	Measure Delay Between TX Trip Point and RX Trip Point		16		μs
TX _{4XDLY} TX _{NormDLY}	TX to BUS Delay	Measure from 2.5V on TX to 3.875V on BUS 4X Mode Normal Mode		3.5 14.5		μs μs
RX _{LTOHdly} RX _{HTOLDly}	RX Output Delay Time	See Figure 4 Measured from BUS Threshold Voltage		1.5 1.9		μs μs
RX _{LTOH} RX _{HTOL}	RX Output Transition Time	Load RX with 50pF to Ground See Figure 5		170 70		ns ns
RX _{LTOH} RX _{HTOL}	RX Output Transition Time During Sleep State	Load RX with 50pF to Ground See Figure 5, Sleep* = 0VDC		170 70		ns ns

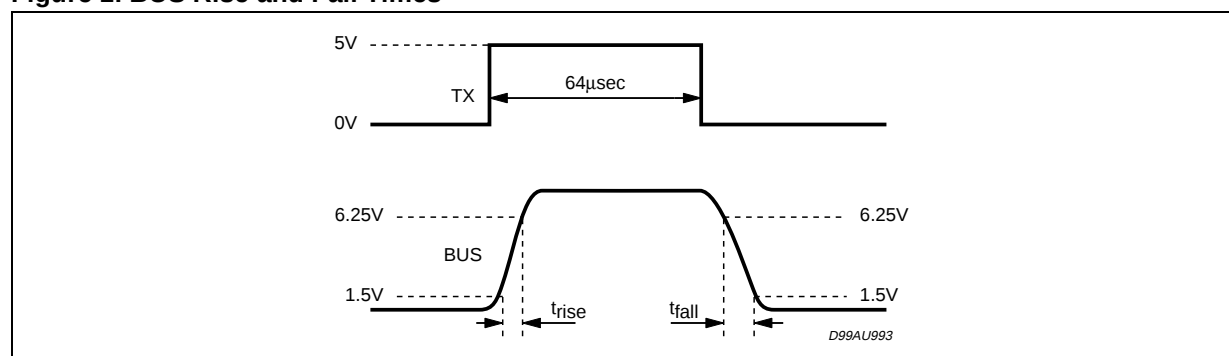
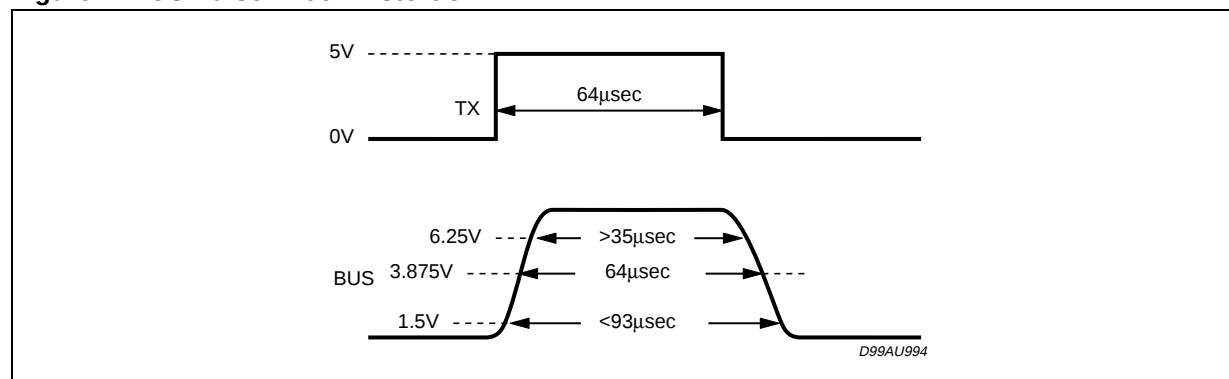
2 BUS TIMING DIAGRAM**Figure 1. BUS Rise and Fall Times****Figure 2. BUS Pulse Width Distortion**

Figure 3. BUS Output Voltage

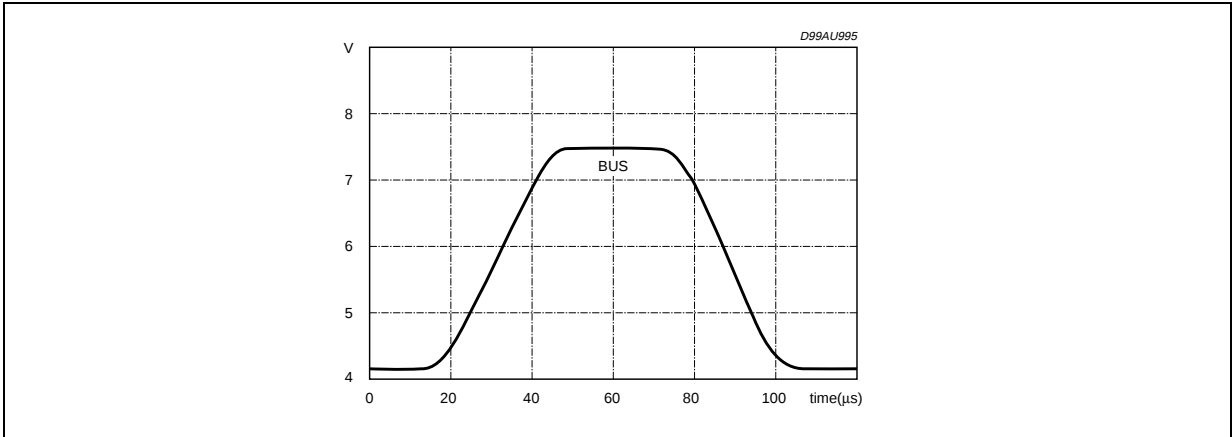
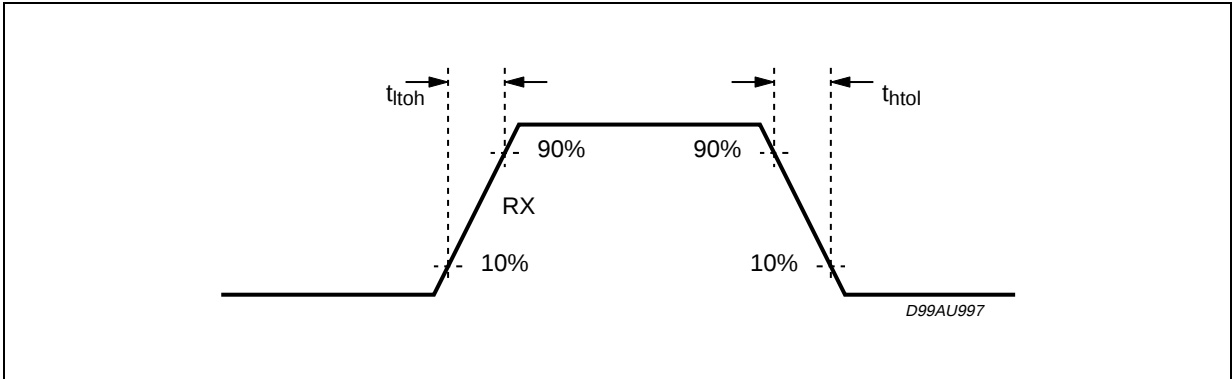
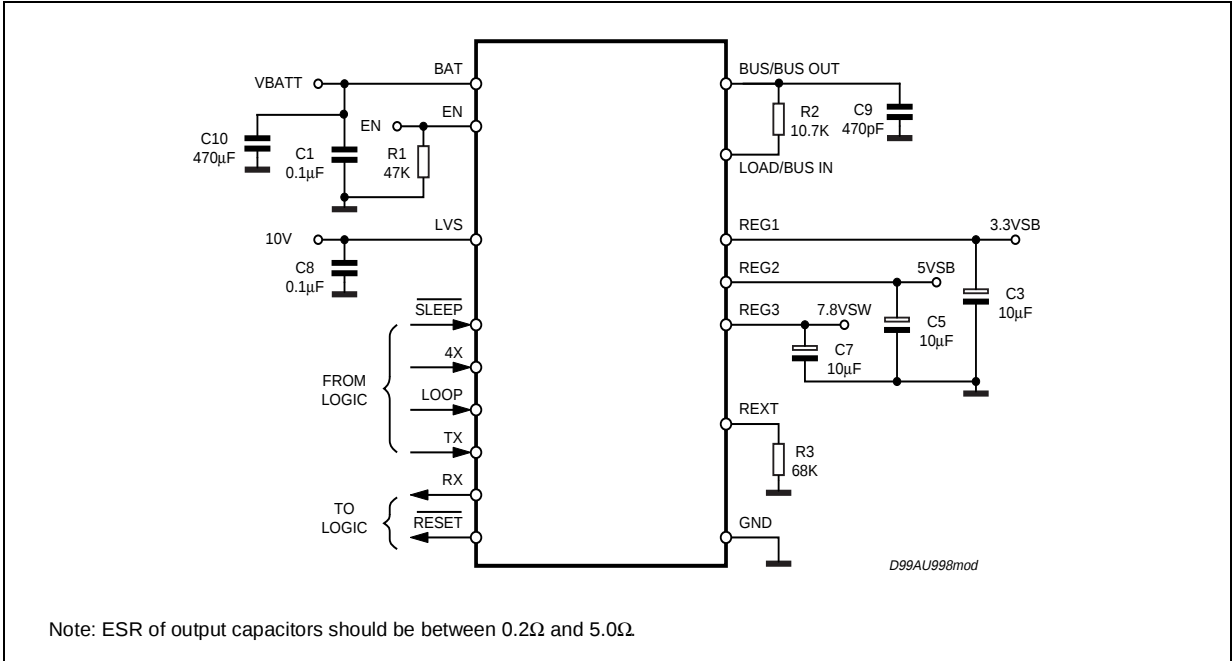


Figure 4. BUS to RX Delay Times



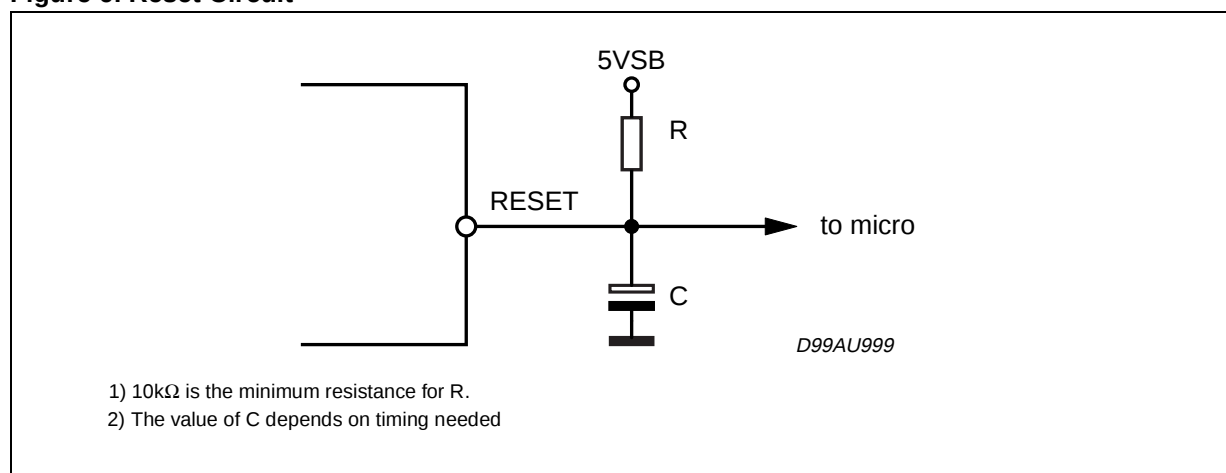
3 TYPICAL APPLICATION CURCUIT

Figure 5. Application Circui



4 TYPICAL RESET CIRCUIT

Figure 6. Reset Circuit



External Components Parts List for Standard Application

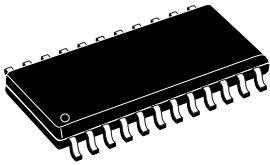
Quantity	Application Description	Part Description	Note Number
5	C1, C8	CAP - 0.1 μ F, 25V	1
3	C3, C5, C7	CAP - Tant 10 μ F, 10V	2
1	R1	RES-47k, 1/16W 5%	3
1	R2	RES - 10.7k, 1/16W, 1%	4
1	R3	RES - 68k, 1/16W, 1%	5
1	C9	CAP - 25V, 470pF	6
1	C10	CAP - 50V, 470pF	1

Notes: (Reasons for This Component Choice)

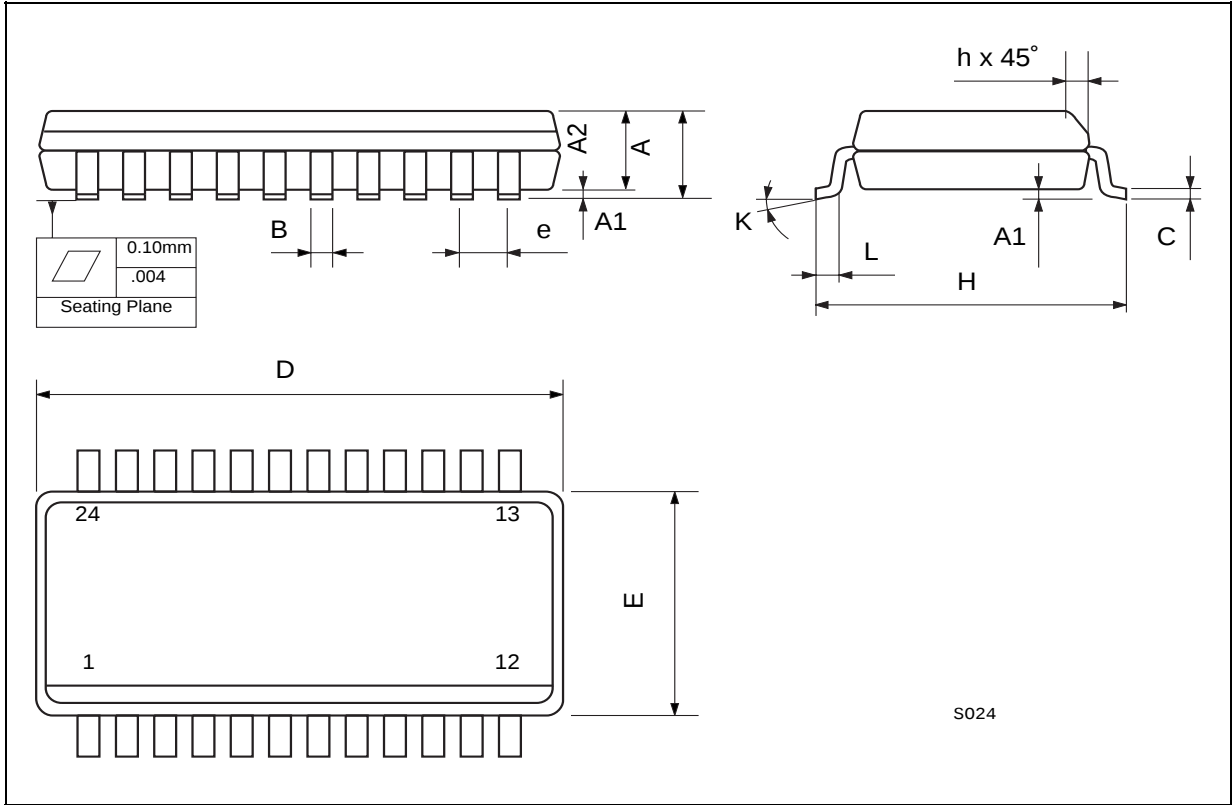
- Noise Suppression
- Output Compensation
- Pull Down Resistor
- Bus Resistor
- Bus Slew Rate Control
- Proper Bus Capacitance

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	2.35		2.65	0.093		0.104
A1	0.10		0.30	0.004		0.012
A2			2.55			0.100
B	0.33		0.51	0.013		0.0200
C	0.23		0.32	0.009		0.013
D	15.20		15.60	0.598		0.614
E	7.40		7.60	0.291		0.299
e		1.27			0,050	
H	10.0		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
k	0° (min.), 8° (max.)					
L	0.40		1.27	0.016		0.050

**OUTLINE AND
MECHANICAL DATA**



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